

L Number	Hits	Search Text	DB	Time stamp
_	607	"Si.sub.x N.sub.y"	USPAT;	2003/05/13 20:05
		·	US-PGPUB	
-	58366	CVD	USPAT;	2003/05/13 20:05
			US-PGPUB	
-	60364	chemical\$2 adj vapor adj deposit\$3	USPAT;	2003/05/13 20:06
			US-PGPUB	
-	501374	oxide	USPAT;	2003/05/13 20:06
			US-PGPUB	
-	110324	"SiO.sub.2"	USPAT;	2003/05/13 20:06
			US-PGPUB	
-	15864	(CVD or (chemical\$2 adj vapor adj deposit\$3)) near4 (oxide	USPAT;	2003/05/13 20:07
		or "SiO.sub.2")	US-PGPUB	
-	10485	BPSG	USPAT;	2003/05/13 20:07
			US-PGPUB	
-	12885	TEOS	USPAT;	2003/05/13 20:07
			US-PGPUB	
-	493	(trench near isolation) and ((thermal\$2 near3 oxid\$5) same	USPAT;	2003/05/13 21:10
		((silicon adj nitride) or "si.sub.3 N.sub.4" or "Si.sub.x	US-PGPUB	
		N.sub.y") same (((CVD or (chemical\$2 adj vapor adj		
		deposit\$3)) near4 (oxide or "SiO.sub.2")) or BPSG or TEOS))		
-	619		USPAT;	2003/05/13 21:14
			US-PGPUB	
-	267	(atomic adj layer adj deposition) and (((silicon adj nitride) or	USPAT;	2003/05/13 21:48
		"si.sub.3 N.sub.4" or "Si.sub.x N.sub.y") and (oxide or	US-PGPUB	
Ì		"SiO.sub.2"))		
_	371	(chemical\$2 adj vapor adj deposit\$3) same (atomic adj layer	USPAT;	2003/05/13 21:49
		adj deposition)	US-PGPUB	